



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chad A. Cobbley et al.

Serial No.: 10/770,941

Filed: February 03, 2004

For: STACKED DIE MODULE AND
TECHNIQUES FOR FORMING A
STACKED DIE MODULE

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Group Art Unit: 2813

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Examiner: Blum, David S.

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Atty Docket: MICS:0078-2/FLE/MAN
(01-0752.02)

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37 C.F.R. 1.8

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September 8, 2005

Date

Kerri Hyland

Sir:

TRANSMITTAL LETTER FOR SUBMISSION OF ISSUE FEE

In response to the Notice of Allowance and Fee(s) Due mailed June 8, 2005, the Commissioner is authorized to charge the requisite fee of \$1,400.00 for the issue fee, \$300.00 for the publications fee, \$3.00 for one soft copy of the patent, and any additional fees which may be required to Deposit Account No. 13-3092; Order No. MICS:0078-2/FLE (01-0752.02).

Respectfully submitted,

Date: September 8, 2005

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